SH74572

RENESAS MCU

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1. Overview

The SH7457 Group is a single-chip RISC (reduced instruction set computer) microcontroller based on a Renesas original RISC CPU core.

Basically the SH7457 Group is the same as the SH7456 Group. Please refer to SH7455 Group, SH7456 Group User's Manual: Hardware Rev.1.10 (Sep 22, 2011). Table 1.1 shows the differences between the SH7456 Group and the SH7457 Group.

* Henceforth, the bold letter portion (shaped portion) shows a difference from SH7456 Group.

Table 1.1 Products

Group	Product	Model	CPU Frequency	Memory Capacity	Package	FlexRay	Operating temperature (Ta)
SH7457	SH74572	R5F74572LBG	240MHz	ROM: 1 Mbyte	PRBG0176GA-A	Yes	-40 to + 105 °C
SH7455	SH74552	R5F74552KBG	160MHz	IL memory: 8 Kbytes,	-	Yes	-40 to +125°C
SH7456	SH74562	R5F74562KBG		OL memory: 16 Kbytes, and SHwyRAM: 256 Kbytes	-	No	
SH7459	SH74593	R5F74593LBG	240MHz	ROM: 1.5 Mbytes IL memory: 8 Kbytes, OL memory: 16 Kbytes, and SHwyRAM: 512 Kbytes	· · ·	Yes	-40 to +105°C

2. Details

This section shows the details of the difference from SH7455 Group, SH7456 Group User's Manual: Hardware Rev.1.10 (Sep 22, 2011). Table 2.1 shows the difference between the SH74562 and the SH74572.

Table 2.1 Difference between SH74562 and SH74572

Page	Description
1-4	Table 1.1 Specifications Overview: Descriptions of CPG
	Product CPU clock (Ick)
	SH74562 160 MHz maximum
	SH74572 240 MHz maximum
1-6	Table 1.1 Specifications Overview: Descriptions of FlexRay
	Product Channels of FlexRay
	SH74562 None: SH7456 Group
	SH74572 Two channels: SH7457 Group



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Page	Description							
1-7	Table 1.1 Specifications Overview: Descriptions of Operating temperature							
	Product Model							
	SH74572 Ta = -40°C to +105°C							
	Table 1.2 Products							
	Product Model FlexRay							
	SH74562 R5F74562KBG No							
	SH74572 R5F74572LBG Yes							
	Please refer to Appendix A.							
1-8	Figure 1.1 Block Diagram							
	Product SH-4A core clock							
	SH74562 SH-4A core (160 MHz maximum)							
	SH74572 SH-4A core (240 MHz maximum)							
1-9	Figure 1.2 Pin Arrangement (Top Transparent View)							
1-15	Table 1.3 Pin Functions of pin A6							
	Product A6 pin							
	SH74562 Vcc							
	SH74572 Vss							
	Please refer to Appendix B.							
14-1	Table 14.1 Relation between Input Frequency and Input Clock							
	Figure 14.1 Block Diagram of CPG							
	Product PLL frequency multiplier (input to CPU)							
	SH74562 X8.							
	SH74572 X12.							
	Please refer to Appendix C.							
14-1	Table 14.1 Relation between Input Frequency and Input Clock							
	Product CPU clock(MHz)							
	SH74562 160.							
	SH74502 100. SH74572 240							
	Please refer to Appendix C.							
15-60	Table 15.9 Minimum of Interrupt Response Time: Response time (Minimum)							
	Product NMI IRQ Peripheral Module Remarks							
	SH74562 40lcyc + S × lcyc 36lcyc + S × lcyc 32lcyc + S × lcyc When lcyc:Scyc: Pcyc = 4:2:1							
	SH74572 55 lcyc + S × lcyc 49 lcyc + S × lcyc 43 lcyc + S × lcyc When lcyc:Scyc: Pcyc = 6:2:1							
38-1	Please refer to Appendix D.							
30-1	Table 38.1 Absolute Maximum Ratings							
	Product Power dissipation (Pd)							
	SH74562 1000 mW ,Ta = -40°C to +125°C							
	SH74572 1200 mW ,Ta = -40°C to + 105 °C							
	Please refer to Appendix E.							
38-1	Table 38.1 Absolute Maximum Ratings							
	Product Operating temperature (Topr)							
	SH74562 -40° C to +125°C							
	SH74572 -40°C to + 105 °C							
	Please refer to Appendix E.							



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Page	Description					
38-10	Table 38.14 DC Characteristics - Supply Current					
	Product Core supply current (Vdd power supply)					
	SH74562 IDD is 480 mA(maximum) Ick = 160 MHz					
	SH74572 IDD is 560 mA(maximum) Ick = 240 MHz					
	Please refer to Appendix F.					
38-11	38.3 AC Characteristics: Descriptions of the timing conditions					
	Product The timing conditions of AC Characteristics					
	SH74562 Ta = -40°C to +125°C					
	SH74572 Ta = -40° C to $+105^{\circ}$ C					
	Please refer to Appendix G.					



Appendix A

Section 1 Overview

1.2 Product Line Overview

Table 1.2 lists the products.

Table 1.2 Products

Product	Model	ROM Capacity	RAM Capacity	Package	FlexRay
SH74552	R5F74552KBG	1 Mbyte	IL memory: 8 Kbytes,	PRBG0176GA-A	Yes
SH74562	R5F74562KBG		OL memory: 16 Kbytes, and		No
SH74572	R5F74572LBG	_	SHwyRAM: 256 Kbytes		Yes
SH74593	R5F74593LBG	1.5 Mbyte	IL memory: 8 Kbytes,	-	Yes
			OL memory: 16 Kbytes, and		
			SHwyRAM: 512 Kbytes		



Appendix B

Section 1 Overview

1.4 Pin Arrangement

Figure 1.2 shows the pin arrangement.

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
Ą	Vss (N.C.)	PG0/ MOSI0/ TO40	PF5/ SCL/ (CTX3)	PF1/ CTX0	DET3OR5	Vss	PL8/ TIA14/ IRQ7/ DREQ3	PL6/ TIA12/ (TIF1A)	PH15/ DROD7/ TO37/ DDC15	PH13/ DROD5/ (TO35)/ DDC13	PH9/ DROD1/ (TO31)/ DDC09/ CTS2#	PH5/ DROD13/ TO25/ DDC05/ TIA01	PH2/ DROD10/ TO22/ DDC02/ TIF1A	PH0/ DROD8/ TO20/ DDC00/ TIF0A	Vss (N.C.)	A
3	PG1/ MISO0/ TO41	PG2/ RSPCK0/ TO42	PG3/ TO43/ SSL00/ (IRQ7)	PF4/ SDA/ (CRX3)	PF0/ CRX0	ASEBRK#/ BRKACK	PL9/ TIA15/ AUDREVT#	PL5/ TIA11/ (TIF0B)	PL2/ DROWR	PH12/ DROD4/ TO34/ DDC12	PH8/ DROD0/ (TO30)/ DDC08/ RTS2#	PH4/ DROD12/ TO24/ DDC04/ TIA00	PH1/ DROD9/ TO21/ DDC01/ TIF0B	PH3/ DROD11/ TO23/ DDC03/ TIF1B	PK14/ AUDRSYNi	в
С	PG4/ IRQ2/ TO44/ SSL01	Vss	WDTOVF#	Vdd	Vdd	Vdd	PL4/ TIA10/ (TIF0A)	Vss	Vcc	PH14/ DROD6/ (TO36)/ DDC14/ IRQ1	PH10/ DROD2/ (TO32)/ DDC10	PH6/ DROD14/ TO26/ DDC06/ TIA02	PK12/ AUDRD3	PK13/ AUDRCLK	PK11/ AUDRD2	с
D	FWE	RESET#	Vss	Vss	Vdd	Vdd	PL3/ IRQ6	Vss	Vcc	PH11/ DROD3/ (TO33)/ DDC11	PH7/ DROD15/ (TO27)/ DDC07/ TIA03	PK8/ DREQ2	PK9/ AUDRD0/ RTS3#	PK10/ AUDRD1/ CTS3#	PK6/ TXD3	D
E	MD1	NMI	Vss	Vss								Vss	PK0/ IRQ5/ SSL10	PK5/ DINC4/ RXD3	PJ14/ TXD1/ MOSI1	Е
F	XTAL	EXTAL	Vss	Vss								Vcc	PJ10/ RXD0/ PWMOFF4/ AD0TRG#	PJ15/ SCK1/ PSPCK1	PJ13/ RXD1/ MISO1	F
G	PLLVss	PLLVcc	MD0	MPMD								PJ1/ (CTX0)/ FTXA	PJ7/ CTX3/ TIF2B/ TXD2	PJ12/ SCK0/ TCLKB/ (IRQ0)	PJ11/ TXD0/ AD0END	G
Η	тск	TMS	MD2	TRST#								PJ0/ (CRX0)/ FRXA	PJ4/ CRX2/ FTXENA/ CTS0#	PJ6/ CRX3/ TIF2A/ RXD2/ TIA04	PJ5/ CTX2/ FTXENB/ SCK2	н
J	PD1/ PDIDATA1	TDO	TDI	Vss								PN1/ AD1IN1	PN0/ AD1IN0	PJ3/ CTX1/ FTXB/ RTS0#	PJ2/ CRX1/ FRXB	J
ĸ	PD4/ PDIDATA4	PD3/ PDIDATA3	Vss	Vss								PN4/ AD1IN4	PN5/ AD1IN5	AVss	AVcc	к
L	PD8/ PDIDATA8	PD7/ PDIDATA7	Vcc	Vcc								PM0/ AD0IN0	AVss	AVREFL	AVREFH	L
м	PD9/ PDIDATA9	PD6/ PDIDATA6	PD0/ PDIDATA0	Vss	Vss	Vss	Vdd	Vdd	PC6/ CLKOUT/ TO36	Vcc	Vss	AVss	PM4/ AD0IN4	AVREFL	AVREFH	М
N	PD10/ PDIWR	PD5/ PDIDATA5	PA4/ TO04/ DDB04	PA7/ TO07/ DDB07	PA10/ TO12/ DDB10/ PSLDATA0	PA11/ TO13/ DDB11/ PSLDATA1	Vdd	Vdd	PC1/ TO31/ MISO2	Vcc	Vss	PM2/ AD0IN2	PM6/ AD0IN6	PM9/ AD0IN9	AVss	N
5	PD2/ PDIDATA2	PA3/ TO03/ DDB03	PA0/ TO00/ DDB00	PA2/ TO02/ DDB02	PA6/ TO06/ DDB06	PA9/ TO11/ DDB09/ PSLCLKA	PA13/ TO15/ DDB13/ PSLDATA3	PB1/ PWMOFF1 DINB1	PC0/ TO30/ MOSI2/ (IRQ6)	PC3/ TO33/ SSL20/ IRQ0	PM15/ AD0IN15	PM13/ AD0IN13	PM11/ AD0IN11	PM8/ AD0IN8	AVcc	Ρ
٦	Vss (N.C.)	PE15/ TO27/ PSLCLR	PA1/ TO01/ DDB01	PA5/ TO05/ DDB05	PA8/ TO10/ DDB08/ PSLCLKB	PA12/ TO14/ DDB12/ PSLDATA2	PB0/ PWMOFF0/ DINB0	PB3/ PWMOFF3 DINB3	PC2/ TO32/ RSPCK2/ DREQ0	PC5/ TO35	PC14	PM14/ AD0IN14	PM12/ AD0IN12	PM10/ AD0IN10	AVcc (N.C.	R
-	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	-

Figure 1.2 Pin Arrangement (Top Transparent View)



Appendix C

Section 14 Clock Generator (CPG)

14.1 Overview

Table 14.1 lists the relation between input frequency and input clock.

Table 14.1 Relation between Input Frequency and Input Clock

	PLL frequency					
Input frequency	multiplier	CPU clock	SHwy clock	Peripheral	Peripheral A	FlexRay clock
(MHz)	(input to CPU)	(MHz)	(MHz)	clock (MHz)	clock (MHz)	(MHz)
20	×12	240	80	40	80	80



Appendix D

Section15 Interrupt Controller (INTC)

15.5 Interrupt Response Time

Table 15.9 shows the interrupt response time, which is the interval from when an interrupt request occurs until the interrupt exception handling is started and the start instruction of the interrupt handling is fetched.

Table 15.9 Interrupt Response Time

	Item	NMI	IRQ	Peripheral Module	– Remarks
Priority determinat	tion time	7 Рсус	6 Pcyc	5Pcyc	
Wait time until the current sequence	CPU finishes the		S-1 (≥ 0) × Icyc		
handling begins (s a SHwy bus reque	n interrupt exception saving SR and PC) until est is issued to fetch the the interrupt handling		11lcyc + 1Scyc		
Response time	Total	(S + 10) lcyc + 1Scyc + 7 Pcyc	(S + 10) lcyc + 1Scyc + 6 Pcyc	(S + 10) lcyc + 1Scyc + 5Pcyc	
	Minimum	55lcyc + S × lcyc	49lcyc + S × lcyc	43lcyc + S × lcyc	When lcyc:Scyc: Pcyc = 6 :2:1

Legend:

Icyc: Period for one CPU clock cycle

Scyc: Period for one SHwy clock cycle

Pcyc: Period for one peripheral clock cycle

S: Number of instruction execution states



Appendix E

Section 38 Electrical Characteristics

38.1 Absolute Maximum Ratings

Table 38.1 shows the absolute maximum ratings.

Table 38.1 Absolute Maximum Ratings

	Item	Symbol	Rating	Unit	Remarks
Power supply	/ _{dd}	Vdd	-0.3 to +2.0	V	
voltage	/cc, PLLVcc	Vcc	–0.3 to +6.5	V	_
1 0	/cc power supply related bins	Vin	-0.3 to Vcc +0.3	V	
Analog supply	/oltage	AVcc	–0.3 to +6.5	V	
Analog referen	ce voltage	AVREFH	-0.3 to AVcc +0.3	V	AVREFH > AVREFL
		AVREFL	-0.3 to AVss +0.3	V	_
Analog input vo	ltage	VAN	-0.3 to AVcc +0.3	V	
Vss differential	voltage	Vss – PLLVss	-0.1 to +0.1	V	
		Vss – AVss	-0.1 to +0.1	V	_
		PLLVss – AVss	-0.1 to +0.1	V	_
Maximum input	Digital input pins	Imax	-20 to +20	mA	
current per pin*	² Analog input pins	Imax	-20 to +20	mA	_
(per pin)					
Power dissipati	on	Pd	1200	mW	Ta = -40°C to + 105 °C
Operating temp	erature*1	topr	–40 to + 105	°C	
Storage temper	ature	tstg	-55 to +125	°C	Before assembly

[Usage Notes]

Operating the MCU in excess of the absolute maximum ratings may result in permanent damage. Be sure to use the MCU in compliance with the connection of power pins, combination conditions of applicable power supply voltages, voltage applicable to each pin, and conditions of output voltage, as specified in the manual. Connecting a non-specified power supply or using the MCU at an incorrect voltage may result in permanent damage of the MCU or the system that contains the MCU.

Notes: *1 This does not guarantee that the microcomputer can operate continuously at 85°C-plus. Consult Renesas if the microcomputer is going to be used for 85°C-plus applications.

*2 Ensure that the current input duration does not exceed 10 ms and that the total current input does not exceed 100 mA.



Appendix F

Section 38 Electrical Characteristics

Table 38.14DC Characteristics - Supply Current

Recommended Operating Conditions: Vcc = PLLVcc = $5.0 \text{ V} \pm 0.5 \text{ V}/3.3 \text{ V} \pm 0.3 \text{ V}$, AVcc = $5.0 \text{ V} \pm 0.5 \text{ V}/3.3 \text{ V} \pm 0.3 \text{ V}$

11	em	Symbol	Min.	Тур.	Max.	Unit	Measurement Conditions
Core supply current (V	dd power supply)	I _{DD}	_	_	560	mA	lck = 240 MHz
System consumption of supply)* ¹ (Including fla programming and eras	I _{CC}	_	_	90	mA	Pck = 40 MHz	
PLL supply current (PL	LVcc power supply)	I _{PLL}	_	_	10	mA	
Analog supply current	During A/D conversion	I _{AVcc}	_	_	10	mA	2 modules,
(AVcc power supply)	Awaiting A/D conversion	_	_	_	1	mA	Pck = 40MHz
ADC reference power	During A/D conversion	I _{AVREF}	_	_	4	mA	2 modules,
supply current (AVREF)	Awaiting A/D conversion	_			3.5	mA	Pck = 40MHz

Notes: *1 An inrush current of about 100 mA will be caused at power on.

• When the A/D converter is not used, do not leave the AVcc, AVref, and AVss pins open.

• The supply current is measured when V_{IH} min = Vcc - 0.5 V, V_{IL} = 0.5 V, with all output pins unloaded.



Appendix G

Section 38 Electrical Characteristics

38.3 AC Characteristics

• The timing conditions without specifications are the following :

 $Vdd = 1.5 V + 0.15 V, -0.1 V, Vcc = PLLVcc = 5.0 V \pm 0.5 V/3.3 V \pm 0.3 V, AVcc = 5.0 V \pm 0.5 V/3.3 V \pm 0.3 V, AVREFH = 4.5 V to AVcc/3.0 V to AVcc,$

 $Vss = PLLVss = AVss = AVREFL = 0 V, Ta = -40^{\circ}C to +105^{\circ}C$

When not otherwise specified, the input threshold value is the value under conditions where all module input pins for the same channel are set to the same characteristics. When not otherwise specified, the output driving ability is the value under conditions where all module output pins for the same channel are set to the same characteristics.

• Standard values are guaranteed when the output load capacity of the measurement pin is 15 pF to 50 pF. Note that the output load capacity of the CLKOUT pin is 15pF to 30pF.

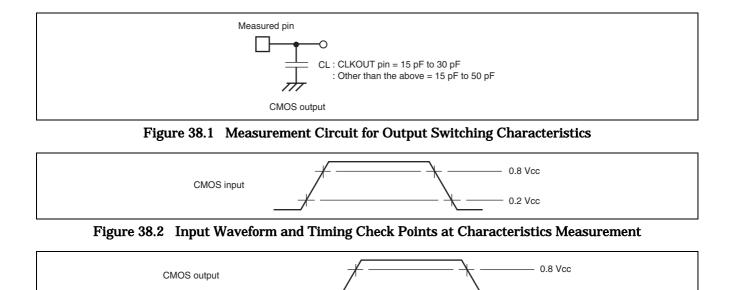




Figure 38.3 Output Timing Check Points at Characteristics Measurement



0.2 Vcc

REVISION HISTORY

SH74572 Datasheet

			Description
Rev.	Date	Page	Summary
1.10	Oct 26, 2011	-	First edition issued
1.20	Sep 10, 2012	Throughout	Document number added
		Datasheet	
		1	1. Overview: Description changed.
			From: the SH7457 Group is the same as the SH7455 Group.
			To : the SH7457 Group is the same as the SH7456 Group.
			Table 1.1 Products: SH7459 Group added.
			Table 2.1 : Title and description changed.
			From: Difference between SH74552 and SH74572
			To : Difference between SH74562 and SH74572
		4	Appendix A Table 1.2 Products: SH7459 Group added.
		Last Page	The following items added
			- General Precautions in the Handing of MPU/MCU Products
			- Notice

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
- 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 - In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do
 not access these addresses; the correct operation of LSI is not guaranteed if they are
 accessed.
- 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.
- 5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

— The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

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